

UNISYS

DATE: October 3, 1994 PPM-94-035

TO: J. Denis/311.1

FROM: K. Sahu/300.1 *ksahu*

SUBJECT: Radiation Report on GOES/SXI
Part No. TC4420
Control No. 9575A

cc: A. Sharma/311
Library/300.1

A radiation evaluation was performed on TC4420 (MOSFET Buffer) to determine the total dose tolerance of these parts. A brief summary of the test results is provided below. For detailed information, refer to Tables I through IV and Figure 1.

The total dose testing was performed using a cobalt-60 gamma ray source. During the radiation testing, four parts were irradiated under bias (see Figure 1 for bias configuration), and one part was used as a control sample. The total dose radiation levels were 2.5, 5, 7.5, 10, 15, 20 and 30 krad*. The dose rate was between 0.04 and 0.59 krad/hour, depending on the total dose level (see Table II for radiation schedule). After the 30 krad irradiation, the parts were annealed at 25°C for 168 hours, after which the parts were annealed at 100°C for 168 hours. After each radiation exposure and annealing treatment, parts were electrically tested according to the test conditions and the specification limits** listed in Table III.

All parts passed initial electrical measurements. All irradiated parts passed all electrical tests up to and including the 7.5 krad irradiation level. At the 10 krad irradiation level, S/N 6, 8 and 9 exceeded the maximum specification limit of 1.5 mA for $I_{cc_3V_18V}$, with readings of 1.73 mA, 1.88 mA and 1.61 mA, respectively, and S/N 8 exceeded the maximum specification limit of 1.5 mA for $I_{cc_3V_4.5V}$, with a reading of 1.56 mA. S/N 10 passed all electrical tests at this radiation level.

At the 15 krad level, S/N 6, 8, 9 and 10 exceeded the maximum specification limits for both $I_{cc_3V_4.5V}$ and $I_{cc_3V_18V}$, with readings in the range of 2.04 to 3.20 mA.

At the 20 krad level, S/N 6, 8, 9 and 10 continued to exceed the maximum specification limit for $I_{cc_3V_4.5V}$ and $I_{cc_3V_18V}$, with readings in the range of 2.77 to 4.65 mA. In addition, S/N 8 marginally exceeded the maximum specification limit of 2.8 Ω for R_{OUT_1} , with a reading of 2.81 Ω .

At the 30 krad level, S/N 6, 8, 9 and 10 continued to exceed the maximum specification limit for $I_{cc_3V_4.5V}$ and $I_{cc_3V_18V}$, with readings in the range of 3.91 to 7.39 mA. The same parts also exceeded the maximum specification limit of 2.8 Ω for R_{OUT_1} , with readings in the range of 2.95 to 3.31 Ω . S/N 6 and 8 also fell below the minimum specification limit of 4.475 V for $V_{OH_4.5V}$, with readings of 4.4742 and 4.4723 V, respectively.

After annealing for 168 hours at 25°C, all irradiated parts read within specification limits for $V_{OH_4.5V}$. No recovery was observed in other test parameters.

*The term rads, as used in this document, means rads(silicon). All radiation levels cited are cumulative.

**These are manufacturer's non-irradiation data specification limits. No post-irradiation limits were provided by the manufacturer at the time these tests were performed. No radiation tolerance/hardness was guaranteed by the manufacturer for this part.

After annealing for 168 hours at 100°C, no rebound effects were observed.

All parts passed all other electrical tests throughout all irradiation and annealing steps.

Table IV provides a summary of the results for each parameter after different irradiation exposures and annealing steps.

Any further details about this evaluation can be obtained upon request. If you have any questions, please call me at (301) 731-8954.

ADVISORY ON THE USE OF THIS DOCUMENT

The information contained in this document has been developed solely for the purpose of providing general guidance to employees of the Goddard Space Flight Center (GSFC). This document may be distributed outside GSFC only as a courtesy to other government agencies and contractors. Any distribution of this document, or application or use of the information contained herein, is expressly conditional upon, and is subject to, the following understandings and limitations:

- (a) The information was developed for general guidance only and is subject to change at any time;
- (b) The information was developed under unique GSFC laboratory conditions which may differ substantially from outside conditions;
- (c) GSFC does not warrant the accuracy of the information when applied or used under other than unique GSFC laboratory conditions;
- (d) The information should not be construed as a representation of product performance by either GSFC or the manufacturer;
- (e) Neither the United States government nor any person acting on behalf of the United States government assumes any liability resulting from the application or use of the information.

TABLE I. Part Information

Generic Part Number:	TC4420
GOES/SXI Part Number:	TC4420*
GOES/SXI Control Number:	9575A
Charge Number:	C444607
Manufacturer:	Teledyne Corp.
Lot Date Code:	9325
Quantity Tested:	5
Serial Number of Control Sample:	7
Serial Numbers of Radiation Samples:	6, 8, 9, 10
Part Function:	MOSFET Buffer
Part Technology:	CMOS
Package Style:	8-pin DIP
Test Equipment:	A540
Test Engineer:	T. Mondy

* No radiation tolerance/hardness was guaranteed by the manufacturer for this part.

TABLE II. Radiation Schedule for TC4420

EVENTS	DATE
1) INITIAL ELECTRICAL MEASUREMENTS	09/07/94
2) 2.5 KRAD IRRADIATION (0.13 KRADS/HOUR) POST-2.5 KRAD ELECTRICAL MEASUREMENT	09/07/94 09/08/94
3) 5 KRAD IRRADIATION (0.13 KRADS/HOUR) POST-5 KRAD ELECTRICAL MEASUREMENT	09/08/94 09/09/94
4) 7.5 KRAD IRRADIATION (0.04 KRADS/HOUR) POST-7.5 KRAD ELECTRICAL MEASUREMENT	09/09/94 09/12/94
5) 10 KRAD IRRADIATION (0.15 KRADS/HOUR) POST-10 KRAD ELECTRICAL MEASUREMENT	09/12/94 09/13/94
6) 15 KRAD IRRADIATION (0.25 KRADS/HOUR) POST-15KRAD ELECTRICAL MEASUREMENT	09/13/94 09/14/94
7) 20 KRAD IRRADIATION (0.25 KRADS/HOUR) POST-20KRAD ELECTRICAL MEASUREMENT	09/14/94 09/15/94
8) 30 KRAD IRRADIATION (0.50 KRADS/HOUR) POST-30 KRAD ELECTRICAL MEASUREMENT	09/15/94 09/16/94
9) 168-HOUR ANNEALING @25°C POST-168 HOUR ANNEAL ELECTRICAL MEASUREMENT	09/16/94 09/26/94
10) 168-HOUR ANNEALING @100°C* POST-168 HOUR ANNEAL ELECTRICAL MEASUREMENT	09/26/94 10/03/94

PARTS WERE IRRADIATED AND ANNEALED UNDER BIAS; SEE FIGURE 1.

*High temperature annealing is performed to accelerate long term time dependent effects (TDE), namely, the "rebound" effect due to the growth of interface states after the radiation exposure. For more information on the need to perform this test, refer to MIL-STD-883D, Method 1019, Para. 3.10.1.

Table III. Electrical Characteristics of TC4420

Unless Otherwise Specified: $T_A = 25^{\circ}\text{C}$, $V_{CC} = +(4.5, 18)\text{Vdc}$, $V_{IL} = 0.8\text{Vdc}$, $V_{IH} = 2.4\text{Vdc}$

TEST NAME	SYMBOL	CONDITIONS	LIMITS	
			MIN	MAX
SUPPLY CURRENT				
I_{CC}	$I_{cc} 0V 4.5V$	$V_{cc} = 4.5Vdc, V_{IN} = 0Vdc$	0.0uA	150.00uA
I_{CC}	$I_{cc} 3V 4.5V$	$V_{cc} = 4.5Vdc, V_{IN} = 3Vdc$	0.0uA	1.50mA
I_{CC}	$I_{cc} 0V 18V$	$V_{cc} = 18Vdc, V_{IN} = 0Vdc$	0.0uA	150.00uA
I_{CC}	$I_{cc} 3V 18V$	$V_{cc} = 18Vdc, V_{IN} = 3Vdc$	0.0uA	1.500mA
INPUT LOGIC THREASHOLDS				
V_{IH}	$V_{IH} 4.5V$	$V_{cc} = 4.5V, V_{out} > 2.5V$	2.4V	
V_{IL}	$V_{IL} 4.5V$	$V_{cc} = 4.5V, V_{out} < 0.025V$		0.8V
V_{IH}	$V_{IH} 18V$	$V_{cc} = 18V, V_{out} > 16.5V$	2.4V	
V_{IL}	$V_{IL} 18V$	$V_{cc} = 18V, V_{out} < 0.025V$		0.8V
OUTPUT TESTS				
V_{OL}	$V_{OL} 4.5V$	$V_{cc} = 4.5Vdc, V_{in} = 0.8Vdc$		0.025V
V_{OH}	$V_{OH} 4.5V$	$V_{cc} = 4.5Vdc, V_{in} = 2.4Vdc$	4.475V	
V_{OL}	$V_{OL} 18V$	$V_{cc} = 18Vdc, V_{in} = 0.8Vdc$		0.025V
V_{OH}	$V_{OH} 18V$	$V_{cc} = 18Vdc, V_{in} = 2.4Vdc$	17.975V	
OUTPUT RESISTANCE				
R_{OUT}	$R_{OUT} 1$	$V_{cc} = 18Vdc, V_{in} = 2.4Vdc, I_{out} = 10mA$		2.8 Ω
R_{OUT}	$R_{OUT} 0$	$V_{cc} = 18Vdc, V_{in} = 0.8Vdc, I_{out} = -10mA$		2.5 Ω
INPUT LEAKAGE CURRENT				
I_{IL}	$I_{IL} 4.5V$	$V_{cc} = 4.5Vdc, V_{in} = 0.0Vdc$	-10.00uA	10.00uA
I_{IH}	$I_{IH} 4.5V$	$V_{cc} = 4.5Vdc, V_{in} = 4.5Vdc$	-10.00uA	10.00uA
I_{IL}	$I_{IL} 18V$	$V_{cc} = 18Vdc, V_{in} = 0.0Vdc$	-10.00uA	10.00uA
I_{IH}	$I_{IH} 18V$	$V_{cc} = 18Vdc, V_{in} = 18Vdc$	-10.00uA	10.00uA

Figure 1. Radiation Bias Circuit for TC4420

